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T2035H Series

Snubberless[™] high temperature 20 A Triacs

Main features

Symbol	Value	Unit
I _{T(RMS)}	20	A
V _{DRM} /V _{RRM}	600	V
I _{GT (Q1)}	35	mA
T _{j MAX}	150	°C

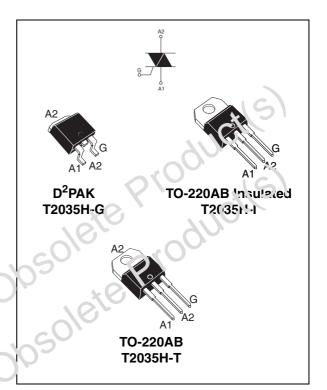
Description

Specifically designed to operate at 150° C, the new 20 A T2035H Triacs provide an enhanced performance in terms of power loss and thermal dissipation. This facilitates the optimization of heatsink dimensioning, leading to improved space and cost effectiveness when compared to electromechanical solutions.

Based on ST Snubberless™ technology, the T2035H series offers high commutation ewitching capabilities and high noise immunity levels on the full range of T_j.

The T2035H series factifiates the optimization of the control of universal motors and inductive loads found in oppliances such as vacuum cleaners and washing machines

The T.2005H Triacs are also suitable for use in high temperature er vilonment found in hot appliances such as cookers, ovens, hobs, electric heaters, and contra machines.



Order code

Part number	Marking
T2035H-600G	T2035H-600G
T2035H-600G-TR	T2035H-600G
T2035H-600TRG	T2035H-600T
T2035H-600IRG	T2035H-600I

TM: Snubberless is a trademark of STMicroelectronics

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1 Characteristics

Table 1.	Absolute maximum ratings	
Symbol		Parameter

Symbol	Parameter			Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)	D ² PAK TO-220AB	T _c = 127° C	20	A
		TO-220AB Ins	T _c = 105° C		
	Non repetitive surge peak on-state current	F = 60 Hz	t = 16.7 ms	210	А
ITSM	(full cycle sine wave, T_j initial = 25° C)	F = 50 Hz	t = 20 ms	200	~
l²t	I ² t Value for fusing	tp = 1	0 ms	283 C	.∿²s
dl/dt	Critical rate of rise of on-state current $I_G = 2xI_{GT}$, tr ≤100 ns	F = 120 Hz	T _j = 125° C	50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off state voltage	•	T _j = 25° C	700	V
I _{GM}	Peak gate current	t _p = 20 μs	$T_j = 750^{\circ} C$	4	А
P _{G(AV)}	Average gate power dissipation	×	T _j = 150° C	OL/	W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	coler	0100	-40 to +150 -30 to +150	°C
Τ _Ι	Maximum leads soldering temperature during	(1)5	N'	260	°C

Table 2. Electrical characteristics (T_i = 25° C, unless otherwise specified)

Symbol	Test cor diaons	Quadrant		Value	Unit
I _{GT} ⁽¹⁾	$V_{\rm D} = 12 \text{ V}, \text{ R}_{\rm I} = 33 \Omega$	- -	MAX	35	mA
V _{GT}	$v_{\rm D} = 12 v, n_{\rm L} = 352$	- -	MAX	1.3	V
V _{GD}	$V_D = v_{j,jE,M}, P_L = 3.3 \text{ k}\Omega, T_j = 150^{\circ} \text{ C}$	- -	MIN	0.15	V
I _H ⁽²⁾	l- = 100 mA		MAX	35	mA
	I _G = 1.2 x I _{GT}	-	МАХ	50	mA
CO C	$r_{G} = 1.2 \times r_{GT}$	Ш	IVIAA	80	
u v/dt ⁽²⁾	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150^{\circ} C$		MIN	300	V/µs
(dl/dt)c ⁽²⁾	Without snubber, T _j = 150° C		MIN	8.9	A/ms

1. minimum I_{GT} is guaranteed at 5% of I_{GT} max

2. for both polarities of A2 referenced to A1

Symbol	Test condition	ons		Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 28 A, t _p = 380 μs	Tj = 25° C	MAX	1.5	V
V _{TO} ⁽¹⁾		Tj = 150° C	MAX	0.80	V
R _D ⁽¹⁾		Tj = 150° C	MAX	21	mΩ
	<u> </u>	Tj = 25° C		5	μA
I _{DRM} I _{RRM}	V _{DRM} = V _{RRM}	Tj = 150° C	MAX	7.4	m۸
'RRM	$V_D/V_R = 400 V$ (at peak mains voltage)	Tj = 150° C		4.8	mA

Table 3. Static electrical characteristics

1. for both polarities of A2 referenced to A1

Table 4. **Thermal resistance**

Symbol	Para	ameter		Va ue	Unit
R _{th (j-c)}	Junction to case for full (AC)		D ² PAK TO-220AB	1	
			TO-220AB In	1.9	S
		$S = 1 \text{ cm}^2$	D ² PA.	45	°C/W
R _{th (j-a)}	Junction to ambient	G	10.220AB Ins	60	

Maximum power dissipation vs Figure 1. RMS on-state current (full cycle)

F gure 2.

RMS on-state current versus case temperature

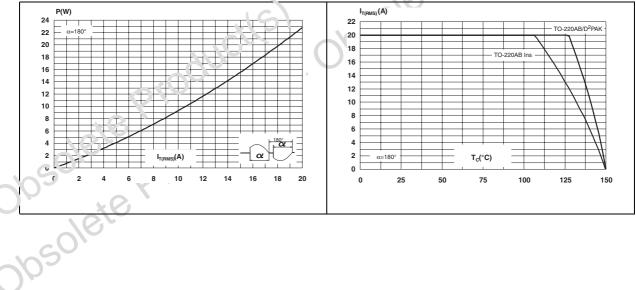
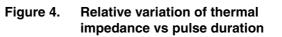
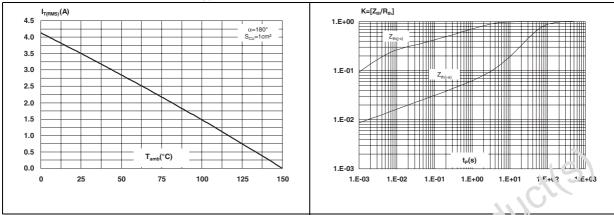




Figure 3. RMS on-state current vs ambient temperature (epoxy printed circuit board FR4 e_{cu} = 35 μm)





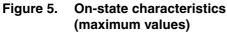


Figure 6. Surge peak on-state current vs number of cycles

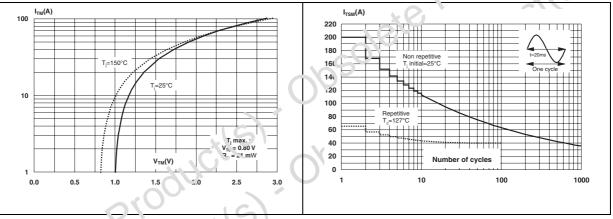
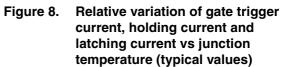


Figure 7. Non repetitive surge peak on-state



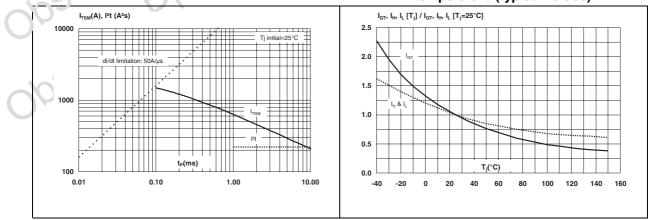
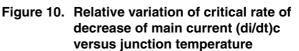


Figure 9. Relative variation of critical rate of decrease of main current (di/dt)c vs reapplied (dV/dt)c



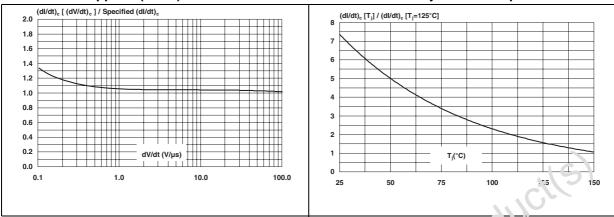
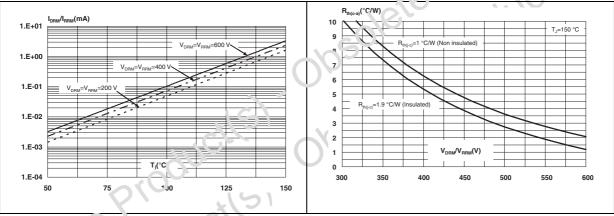
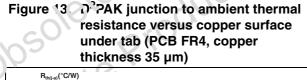
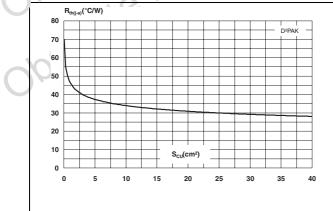


Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)

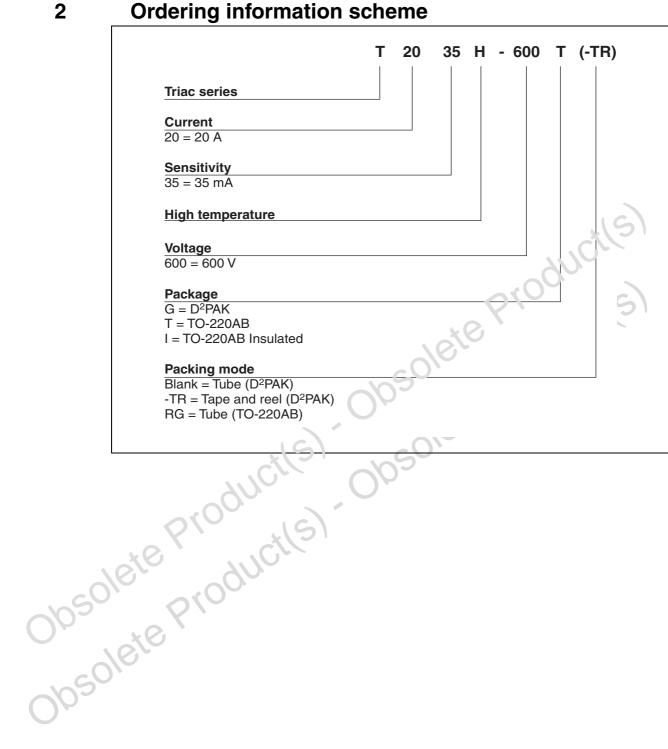
Figure 12. Acceptable repelitive peak off-state voltage versus case-ambient thermel resistance















3 Package information

				DIMEN	ISIONS	;	
	REF.	Mi	illimete	rs		Inches	i
		Min.	Тур.	Max.	Min.	Тур.	Max.
	А	15.20		15.90	0.598		0.625
в	a1		3.75			0.147	
	a2	13.00		14.00	0.511	10	L 551
	В	10.00		10.40	0.393		0.409
	b1	0.61		0.88	C 02`4		0.034
	b2	1.23		1.32	<i>ن</i> .048		0.051
	С	4.40		1.60	0.173		0.181
	c1	0.49		0.70	0.019		0.027
12 a2	c2	2.10		2.72	0.094		0.107
		2.40	0	2.70	0.094		0.106
	F	6.20	X	6.60	0.244		0.259
e	ØI	3.75	C	3.85	0.147		0.151
16	14	15.80	16.40	16.80	0.622	0.646	0.661
	2	2.65		2.95	0.104		0.116
<i>200</i> 04	12	1.14		1.70	0.044		0.066
~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	13	1.14		1.70	0.044		0.066
P1 (5)	М		2.60			0.102	
obsolete Production							

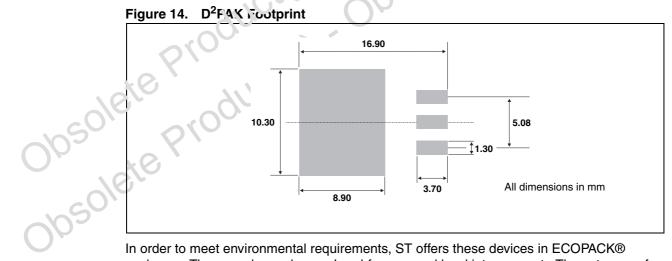
Table 5. TO-220AB and TO-220AB Insulated dimensions



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				DIMEN	SIONS	
		REF.	Millim	neters	Inc	hes
			Min.	Max.	Min.	Max.
		Α	4.40	4.60	0.173	0.181
	<b>▲</b>	A1	2.49	2.69	0.098	0.106
E	C2→	A2	0.03	0.23	0.001	0.009
		В	0.70	0.93	0.027	0.037
	D	B2	1.14	1.70	0.045	C.967
		С	0.45	0.60	0.017	0.024
	<u>A1</u>	C2	1.23	1.36	1.043	0.054
B2	/ <u>c</u> , <u>r</u>	D	8.95	9.35	0.352	0.368
		E	10.00	16.40	0.393	0.409
ŭ		G	1 88	5.28	0.192	0.208
	2mm min. FLAT ZONE		າວ.00	15.85	0.590	0.624
			1.27	1.40	0.050	0.055
	V2	L3	1.40	1.75	0.055	0.069
	OF	М	2.40	3.20	0.094	0.126
		R	0.40	typ.	0.01	6 typ.
	*(5)	V2	0°	8°	0°	8°

Table 6.D²PAK dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

#### **Ordering information** 4

Part number	Marking	Package	Weight	Base Qty	Packing mode
T2035H-600G	T2035H-600G	D ² PAK	1.5 g	50	Tube
T2035H-600G-TR	T2035H-600G	D ² PAK	1.5 g	1000	Tape and Reel
T2035H-600TRG	T2035H-600T	TO-220AB	2.3 g	50	Tube
T2035H-600IRG	T2035H-600I	TO-220ABIns	2.3 g	50	Tube

#### 5 **Revision history**

Date	Revision	Charges
13-Jul-2006	1	Initial release.
7-Sep-2006	2	Added TO-220AB Insulated package.
	ucil	01050
ate Prof		61 01050

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